

Special Issue

Sustainable Food Packaging and Process Optimization: From Material Innovation to System Integration

Message from the Guest Editors

This Special Issue, “Sustainable Food Packaging and Process Optimization: From Material Innovation to System Integration”, seeks high-quality studies on the latest advances in sustainable food package design, novel food packaging materials/material combinations, and their integration into the food system. Topics include, but are not limited to

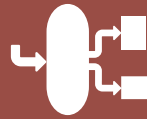
- New food packaging materials;
- Sustainable food package design;
- Material sustainability;
- Energy conservation;
- Smart packaging in food handling.

Guest Editors

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